

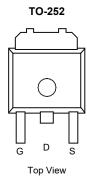
P-Channel 30 V (D-S) MOSFET

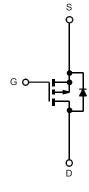
PRODUCT SUMMARY				
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a		
- 30	0.009 at V _{GS} = - 10 V	-60		
- 30	0.011 at V _{GS} = - 4.5 V	-58		

FEATURES

Compliant to RoHS Directive 2002/95/EC







P-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Gate-Source Voltage		V _{GS}	± 20	V	
Continuous Drain Current ($T_1 = 175 ^{\circ}C$)	T _C = 25 °C		- 70ª	А	
Continuous Drain Current (1j = 175°C)	T _C = 125 °C		- 58		
Pulsed Drain Current	I _{DM}	- 240	A		
Avalanche Current	I _{AR}	- 60			
Repetitive Avalanche Energy ^b	L = 0.1 mH	E _{AR}	180	mJ	
Power Dissinction	T _C = 25 °C	D	87 ^d	W	
Power Dissipation -	T _A = 25 °C	- P _D	78		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Limit	Unit	
Junction-to-Ambient	PCB Mount		60		
	Free Air	R _{thJA}	68.5	°C/W	
Junction-to-Case		R _{thJC}	1.0		

Notes:

a. Package limited.

b. Duty cycle \leq 1 %.

c. When mounted on 1" square PCB (FR-4 material).

d. See SOA curve for voltage derating.

* Pb containing terminations are not RoHS compliant, exemptions may apply.

Parameter Static

Drain-Source Breakdown Voltage

Gate Threshold Voltage

SPECIFICATIONS (T_J = 25 °C, unless otherwise noted)

Symbol

 V_{DS}

V_{GS(th)}

		ζ	NB.	® VBset
oted)				
Test Conditions	Min.	Тур.	Max.	Unit
	1		1	1
_{GS} = 0 V, I _D = - 250 μA	- 30			v
_{os} = V _{GS} , I _D = - 250 μA	- 1		- 3	
$x = 0 V V_{cc} = + 20 V$			± 100	nA

0	()	- D3 - G3, D = = = P				
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
		V _{DS} = - 30 V, V _{GS} = 0 V			- 1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 30 V, V _{GS} = 0 V, T _J = 125 °C			- 50	μA
		V _{DS} = - 30 V, V _{GS} = 0 V, T _J = 175 °C			- 250	
On-State Drain Current ^a	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 10 V	- 120			А
		V _{GS} = - 10 V, I _D = - 30 A		0.009		Ω
Drain-Source On-State Resistance ^a	B	V _{GS} = - 10 V, I _D = - 30 A, T _J = 125 °C		0.012		
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = - 10 V, I _D = - 30 A, T _J = 175 °C		0.013		
		V _{GS} = - 4.5 V, I _D = - 20 A		0.011		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 75 A	20			S
Dynamic ^b				•	•	
Input Capacitance	C _{iss}			4000		
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = - 25 V, f = 1 MHz		1565		pF
Reversen Transfer Capacitance	C _{rss}			715		
Total Gate Charge ^c	Qg			160	240	nC
Gate-Source Charge ^c	Q _{gs}	V _{DS} = - 15 V, V _{GS} = - 10 V, I _D = - 75 A		32		
Gate-Drain Charge ^c	Q _{gd}			30		
Turn-On Delay Time ^c	t _{d(on)}			25	40	
Rise Time ^c	tr	$V_{DD} = -15 \text{ V}, \text{ R}_{\text{L}} = 0.2 \Omega$		225	360	- ns
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong -75 \text{ A}, V_{GEN} = -10 \text{ V}, \text{ R}_g = 2.5 \Omega$		150	240	
Fall Time ^c	t _f			210	340	
Source-Drain Diode Ratings and Cha	racteristics ^b ((T _C = 25 °C)		•		
Continuous Current	I _S				- 70	٨
Pulsed Current	I _{SM}				- 240	A
Forward Voltage ^a	V _{SD}	I _F = - 75 A, V _{GS} = 0 V		- 1.2	- 1.5	V
Reverse Recovery Time	t _{rr}			55	100	ns
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = - 75 A, dl/dt = 100 A/μs		2.5	5	А
Reverse Recovery Charge	Q _{rr}	1		0.07	0.25	μC

 V_{GS} = 0 V, I_D = -

 $V_{DS} = V_{GS}, I_D = -$

Notes:

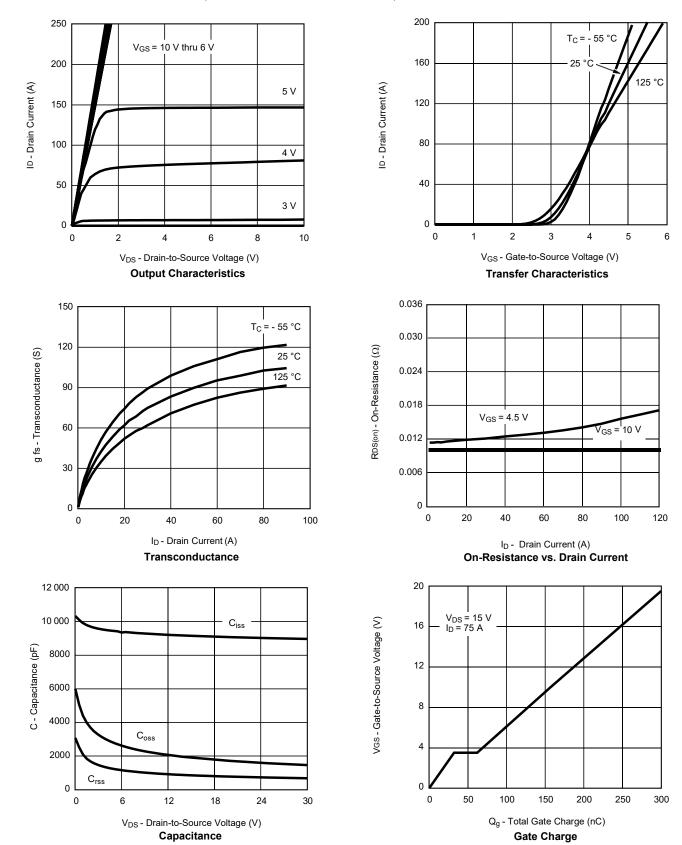
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



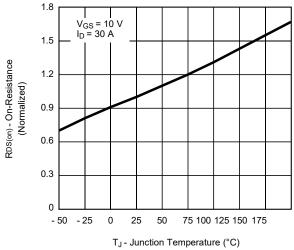


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

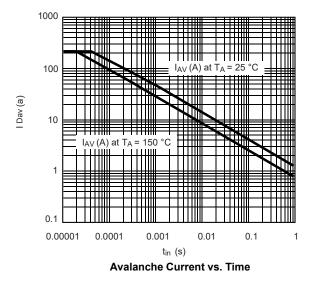
服务热线:400-655-8788

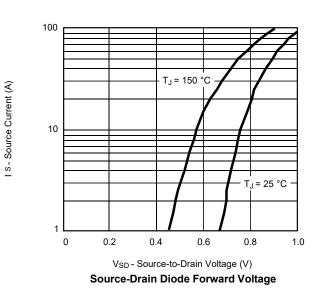


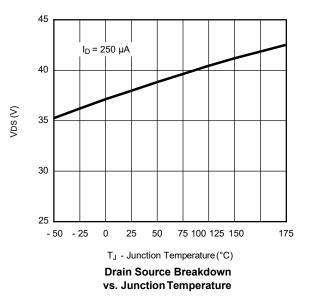
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



On-Resistance vs. Junction Temperature

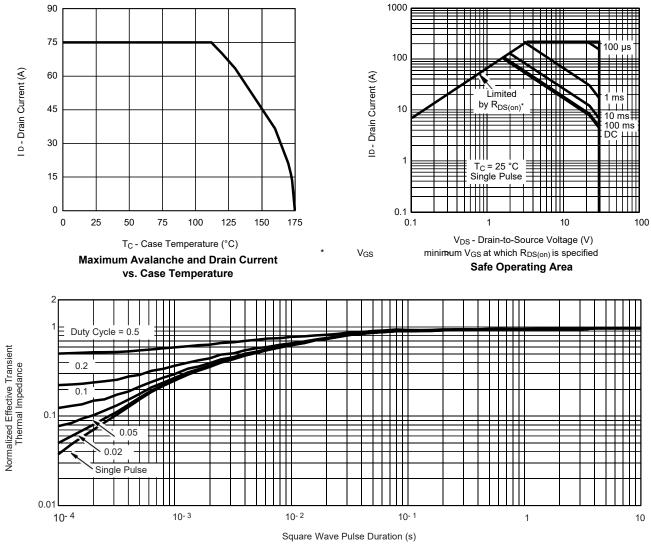








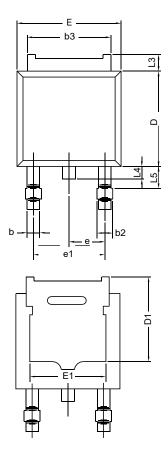
THERMAL RATINGS

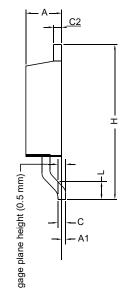


Normalized Thermal Transient Impedance, Junction-to-Case



TO-252AA CASE OUTLINE





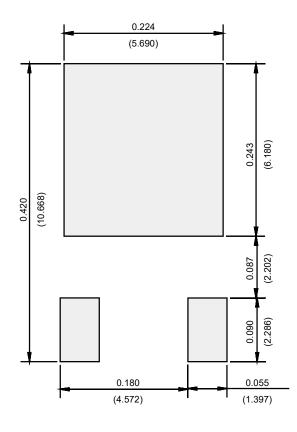
	MILLIN	IETERS	INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	5.21	-	0.205	-	
Е	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28	BSC	0.090 BSC		
e1	4.56	BSC	0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.14	1.52	0.045	0.060	
ECN: X12- DWG: 534	⊥ ·0247-Rev. M, 7	24-Dec-12	1	1	

Note

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)



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